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Global Air Reflow Oven for PCB and Semiconductor Market 2026 by Manufacturers, Regions, Type and Application, Forecast to 2032

https://marketpublishers.com/r/G4877C9A013BEN.html
Date: September 2026
Pages: 133
Price: US$ 3,480.00 (Single User License)
ID: G4877C9A013BEN

Abstracts

According to our (Global Info Research) latest study, the global Air Reflow Oven for PCB and Semiconductor market size was valued at US$ 1111 million in 2025 and is forecast to a readjusted size of US$ 1873 million by 2032 with a CAGR of 7.8% during review period.

In 2025, global Air Reflow Oven for PCB and Semiconductor production reached approximately 6,000 units, with an average global market price of around USD 180,000 per unit.

The gross profit margin of major companies in the industry was approximately 28%–43%.

In 2025, global production capacity was approximately 7,600 units.

An Air Reflow Oven for PCB and Semiconductor is a controlled-atmosphere heating system that uses circulated hot air to melt solder paste and form reliable electrical joints between electronic components and substrates. It provides multiple heating, soaking, reflow, and cooling zones with precise temperature and conveyor control. Applications include surface-mount PCB assembly, semiconductor packaging, power-module production, and advanced electronics manufacturing. The product boundary excludes vapor-phase reflow systems, vacuum reflow ovens, wave-soldering machines, and laboratory batch ovens.

The upstream segment includes heaters, blowers, motors, conveyors, thermal insulation, temperature sensors, controllers, cooling modules, exhaust systems, and

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structural components. Midstream manufacturers conduct thermal-process design, mechanical assembly, control-software development, system integration, calibration, and reliability testing. Downstream users include electronics manufacturing service providers, PCB assemblers, semiconductor packaging companies, automotive-electronics manufacturers, consumer-electronics plants, and power-device producers. Supporting activities include production-line integration, temperature-profile optimization, maintenance, spare-parts supply, and software upgrades.

This reflow oven completes solder joint heating and curing for circuit boards and semiconductor packaging devices with uniform temperature distribution and low oxidation rate. High-end electronics manufacturing expansion boosts market growth. New equipment optimizes intelligent temperature zone independent control and energy-saving air circulation structure.

Report Scope

This report is a detailed and comprehensive analysis for global Air Reflow Oven for PCB and Semiconductor market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Air Reflow Oven for PCB and Semiconductor market size and forecasts, in consumption value ($ Million), sales quantity (Units), and average selling prices (US$/Unit), 2021-2032

Global Air Reflow Oven for PCB and Semiconductor market size and forecasts by region and country, in consumption value ($ Million), sales quantity (Units), and average selling prices (US$/Unit), 2021-2032

Global Air Reflow Oven for PCB and Semiconductor market size and forecasts, by Type and by Application, in consumption value ($ Million), sales quantity (Units), and average selling prices (US$/Unit), 2021-2032

Global Air Reflow Oven for PCB and Semiconductor market shares of main players,

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shipments in revenue ($ Million), sales quantity (Units), and ASP (US$/Unit), 2021-2026

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for Air Reflow Oven for PCB and Semiconductor

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global Air Reflow Oven for PCB and Semiconductor market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Heller Industries, Inc., Rehm Thermal Systems GmbH, Kurtz Ersa GmbH, BTU International, Inc., ITW EAE, SEHO Systems GmbH, Tamura Corporation, Suneast Co., Ltd., SMIC Co., Ltd., ASYS Group, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

Air Reflow Oven for PCB and Semiconductor market is split by Type and by Application. For the period 2021-2032, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market segment by Type

Forced-convection Reflow Oven

Infrared-convection Reflow Oven

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Hot-air Circulation Reflow Oven

Market segment by Production Configuration

Batch Reflow Oven

In-line Reflow Oven

Dual-lane Reflow Oven

Market segment by Heating Zone Count

Compact Type??8 zones?

Standard Type??8–12 zones?

Multi-zone Type??12 zones?

Market segment by Application

Printed Circuit Board Assembly

Semiconductor Package Assembly

Power Module Assembly

Other

Major players covered

Heller Industries, Inc.

Rehm Thermal Systems GmbH

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Kurtz Ersa GmbH

BTU International, Inc.

ITW EAE

SEHO Systems GmbH

Tamura Corporation

Suneast Co., Ltd.

SMIC Co., Ltd.

ASYS Group

ETA Technology Co., Ltd.

JT Automation Equipment Co., Ltd.

Shenzhen Jaguar Automation Equipment Co., Ltd.

Shenzhen Folungwin Automatic Equipment Co., Ltd.

Dongguan ICT Technology Co., Ltd.

Shenzhen ETA Electronic Equipment Co., Ltd.

Shenzhen Chuxiong Technology Co., Ltd.

Shenzhen Grandseed Technology Development Co., Ltd.

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

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Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

Chapter Outline

Chapter 1, to describe Air Reflow Oven for PCB and Semiconductor product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Air Reflow Oven for PCB and Semiconductor, with price, sales quantity, revenue, and global market share of Air Reflow Oven for PCB and Semiconductor from 2021 to 2026.

Chapter 3, the Air Reflow Oven for PCB and Semiconductor competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Air Reflow Oven for PCB and Semiconductor breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2021 to 2032.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2021 to 2032.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2021 to 2026.and Air Reflow Oven for PCB and Semiconductor market forecast, by regions, by Type, and by Application, with sales and revenue, from 2027 to 2032.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Air Reflow Oven for PCB and Semiconductor.

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Chapter 14 and 15, to describe Air Reflow Oven for PCB and Semiconductor sales channel, distributors, customers, research findings and conclusion.

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